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Silicon N Channel MOS FET High Speed Power Switching

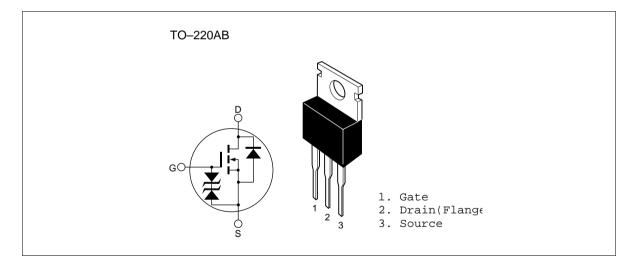


ADE-208-552C (Z) 4th. Edition Jul. 1998

Features

- Low on-resistance
 - $R_{DS} = 0.026 \Omega$ typ.
- High speed switching
- 4V gate drive device can be driven from 5V source

Outline



Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	25	A
Drain peak current	Note1 D(pulse)	100	A
Body-drain diode reverse drain current	I _{DR}	25	A
Avalanche current	AP Note3	20	A
Avalanche energy	E _{AR} ^{Note3}	34	mJ
Channel dissipation	Pch Note2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. PW \leq 10µs, duty cycle \leq 1 %

2. Value at Tc = 25°C

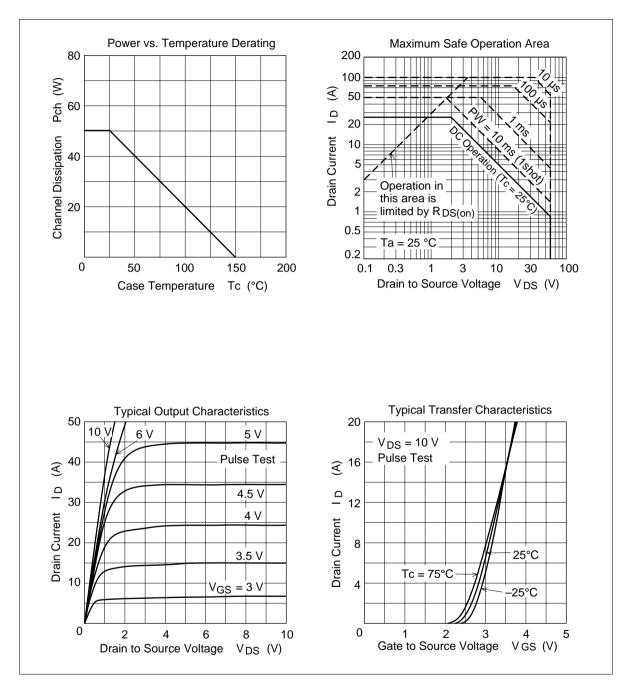
3. Value at Tch = 25° C, Rg 50 Ω

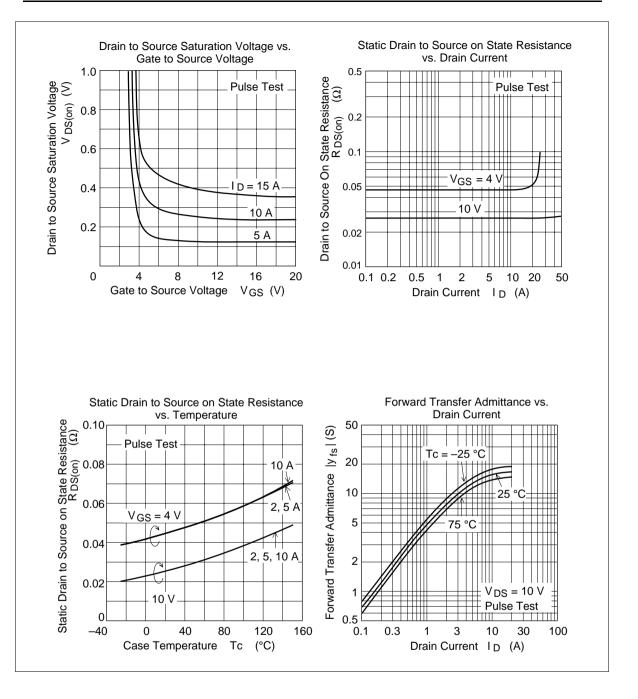
Electrical Characteristics (Ta = 25° C)

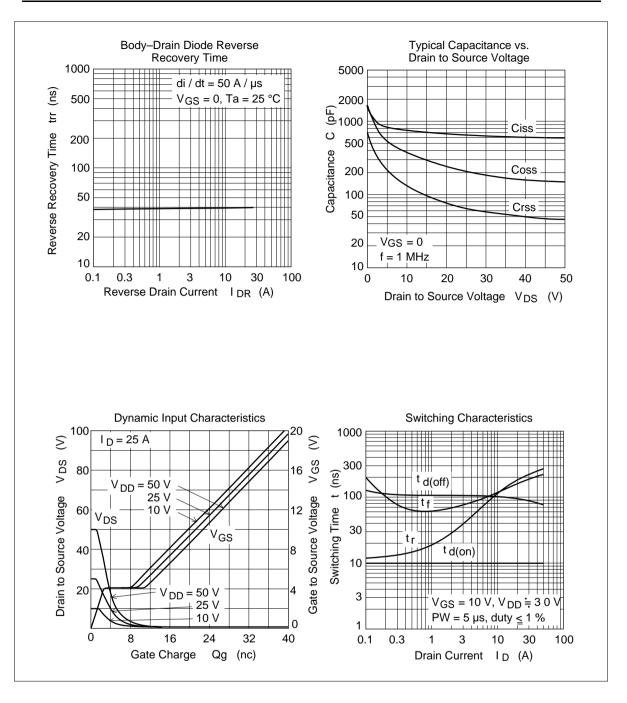
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_		10	μA	$V_{\rm DS} = 60 \text{ V}, V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.5	—	2.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
Static drain to source on state	$R_{DS(on)}$	_	0.026	0.034	Ω	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10 V^{\rm Note4}$
resistance	$R_{\text{DS(on)}}$		0.045	0.07	Ω	$I_D = 15A$, $V_{GS} = 4V^{Note4}$
Forward transfer admittance	y _{fs}	11	17	_	S	$I_{\rm D} = 15$ A, $V_{\rm DS} = 10$ V ^{Note4}
Input capacitance	Ciss		740	_	pF	V _{DS} = 10V
Output capacitance	Coss	—	380	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	140	_	pF	f = 1MHz
Turn-on delay time	t _{d(on)}		10	_	ns	$I_{\rm D} = 15$ A, $V_{\rm GS} = 10$ V
Rise time	t,	—	160	_	ns	$R_{L} = 2\Omega$
Turn-off delay time	$t_{d(off)}$		100	_	ns	
Fall time	t _r	—	150	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.95	_	V	$I_{\rm F} = 25$ A, $V_{\rm GS} = 0$
Body–drain diode reverse recovery time	t _{rr}	—	40	—	ns	$I_{F} = 25A, V_{GS} = 0$ diF/ dt =50A/µs

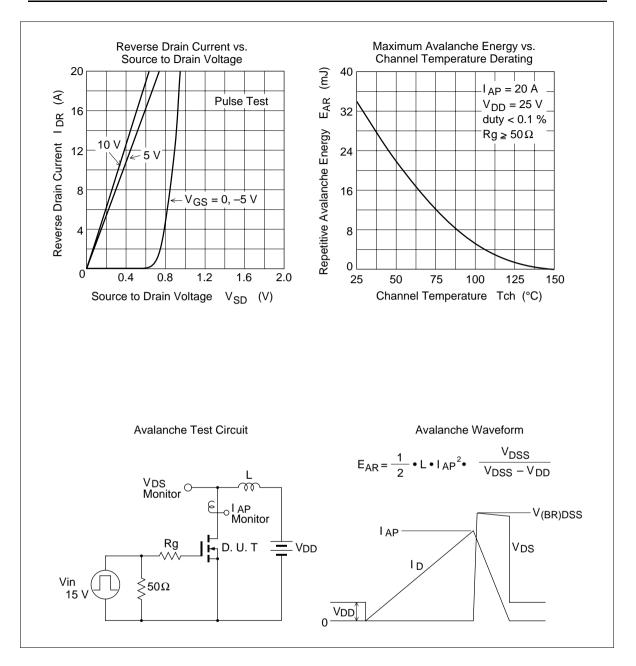
Note: 4. Pulse test

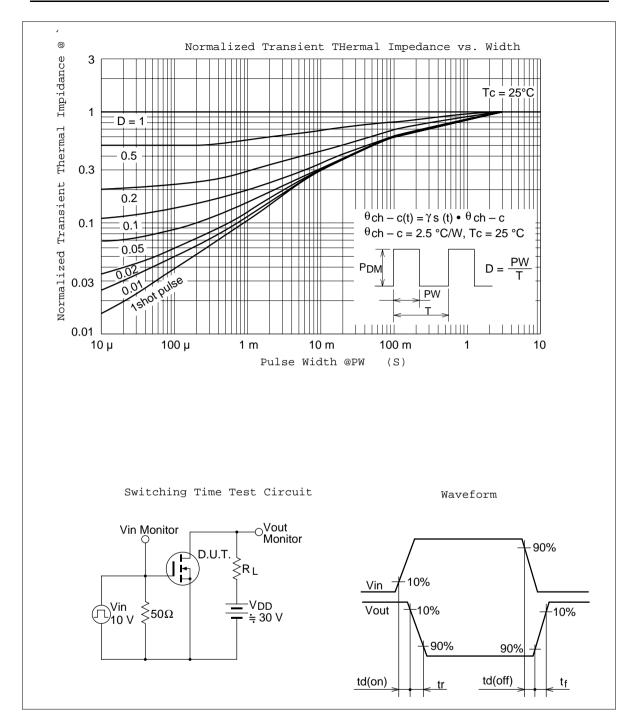
Main Characteristics



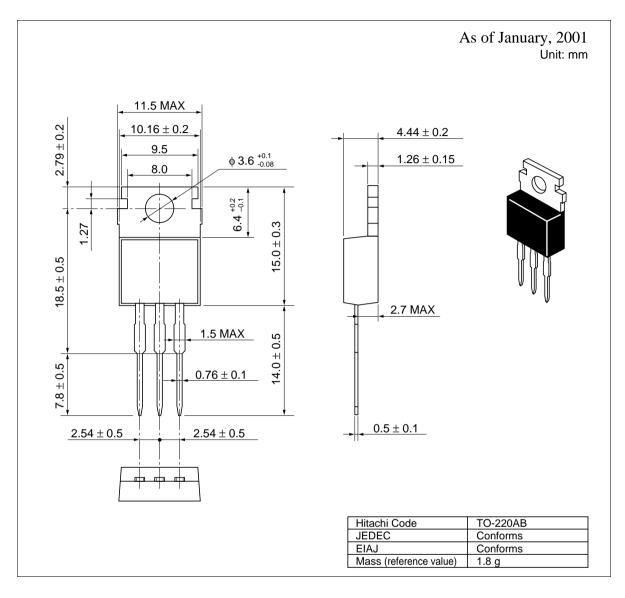








Package Dimensions



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